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ISSUE CLASSIFICATION	
Class	Subclass

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PATENT NUMBER

U.S. **UTILITY** Patent Application

H.H.	O.I.P.E.	PATENT DATE
SCANNED  Q.A. 		

APPLICATION NO. 09/925427	CONT/PRIOR D F	CLASS 428	SUBCLASS	ART UNIT 1775	EXAMINER Jenkins
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APPLICANTS

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Still

Substrate material for mounting a semiconductor device, substrate
for mounting a semiconductor device, semiconductor device, and
method of producing the same

PTO-2040
12/89[illegible]

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS		CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims
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Amount Due			Date Paid	
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